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Dual Output LCD Bias for Smartphones and Tablets

General Description

The RT4801H is a highly integrated Boost and LDO and inverting charge pump to generate positive and negative output voltage. The output voltages can be adjusted from $\pm 4V$ to $\pm 6V$ with 100mV steps by I 2C interface protocols. With its input voltage range of 2.5V to 5.5V, RT4801H is optimized for products powered by single-cell batteries and symmetrical output currents up to 80mA. The RT4801H is available in the WL-CSP-15B 1.31x2.07 (BSC) package.

Ordering Information



Note:

Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

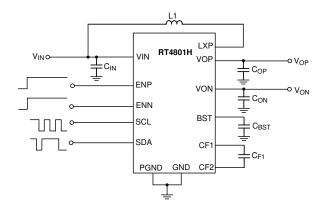
Features

- 2.5V to 5.5V Supply Voltage Range
- Up to 90% Efficiency with Small Magnetics
- Support Up to 80mA Output Current
- Low 1µA Shutdown Current
- Internal Soft-start Function
- Short Circuit Protection Function
- Over-Voltage Protection Function
- Over-Current Protection Function
- Over-Temperature Protection Function
- Elastic Positive and Negative Voltage On/Off Control by ENP/ENN
- Voltage Output from 4V to 6V per 0.1V
- Low Input Noise and EMI
- Output with Programmable Fast Discharge when IC Shutdown
- Adjustable Output Voltage by I²C Compatible Interface
- Available in the 15-Ball WL-CSP Package

Applications

- TFT-LCD Smartphones
- TFT-LCD Tablets
- General Dual Power Supply Applications

Simplified Application Circuit

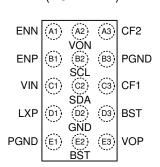


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Pin Configurations

(TOP VIEW)



Marking Information



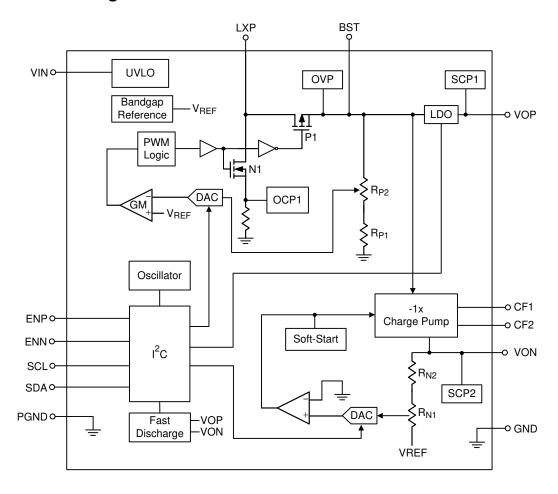
WL-CSP-15B 1.31x2.07 (BSC)

Functional Pin Description

Pin No.	Pin Name	Pin Function
A1	ENN	Enable Control Input for VON.
A2	VON	Negative Terminal Output.
A3	CF2	Negative Charge Pump Flying Capacitor Pin.
B1	ENP	Enable Control Input for VOP.
B2	SCL	Clock of I ² C.
B3, E1	PGND	Power Ground.
C1	VIN	Power Input.
C2	SDA	Data of I ² C.
C3	CF1	Negative Charge Pump Flying Capacitor Pin.
D1	LXP	Switching Node of Boost Converter.
D2	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
D3, E2	BST	Output Voltage of Boost Converter.
E3	VOP	Positive Terminal Output.



Function Block Diagram



Operation

The RT4801H is a highly integrated Boost, LDO and inverting charge pump to generate positive and negative output voltages for LCD panel bias or consumer products. It can support input voltage range from 2.5V to 5.5V and the output current up to 80mA. Both positive and negative voltages can be programmed by a MCU through the dedicated I²C

interface. The RT4801H provides Over-Temperature Protection (OTP) and Short Circuit Protection (SCP) mechanisms to prevent the device from damage with abnormal operations. When the EN voltage is logic low for more than $375\mu s$, the IC will be shut down with low input supply current less than $1\mu A$.



Absolute Maximum Ratings (Note 1)

Supply Input Voltage V _{IN} Pin	0.3V to 6V
Output Voltage VOP Pins	0.3V to 7V
Output Voltage VON Pins	7V to 0.3V
Others Pin to GND	0.3V to 6V
 Power Dissipation, P_D @ T_A = 25°C 	
WL-CSP-15B 1.31x2.07 (BSC)	2.00W
Package Thermal Resistance (Note 2)	
WL-CSP-15B 1.31x2.07 (BSC), θ_{JA}	49.8°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
• Junction Temperature	150°C
Storage Temperature Range	–65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
MM (Machine Model)	200V
Recommended Operating Conditions (Note 4)	
Supply Input Voltage	2.5V to 5.5V

Electrical Characteristics

 $\underline{(V_{IN} = 3.7 V, \, C_{IN} = C_{OP} = C_{F1} = 4.7 \mu F, \, C_{BST} = C_{ON} = 10 \mu F, \, L1 = 2.2 \mu H, \, T_A = 25 ^{\circ}C, \, unless \, otherwise \, specified.)}$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Power Supply						
Input Voltage Range	V _{IN}		2.5		5.5	V
Under Voltage Lockout	Vuvlo_h	V _{IN} Rising			2.5	V
Threshold Voltage	Vuvlo_L	V _{IN} Falling			2.3	V
Over-Temperature Protection	T _{OTP}	(Note 5)		140		°C
Over-Temperature Protection Hysteresis	T _{OTP} _HYST	(Note 5)		15		°C
Shutdown Current	I _{SHDN}	ENP = ENN = 0V			1	μΑ
Boost Converter						
Boost Voltage Range	V _{BST}		4.15		6.2	V
Peak Current Limit	IOCP			1		Α
Boost Switching Frequency	fosc_p		0.8	1	1.2	MHz

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RT4801H



Parame	ter	Symbol	Test Conditions	Min	Тур	Max	Unit
LDO				•	l.	l.	I.
Positive Output Vo	ltage Range	V _{OP}		4		6	V
Positive Output Vo Range	ltage Setting	VOP_SET	per step		100		mV
Positive Output Vo Accuracy	ltage	V _{OP_ACC}		-1		1	%
Positive Output Cu Capability	ırrent	I _{OP_MAX}				80	mA
Dropout Voltage		V _{OP_DROP}	$V_{BST} = 5.4V, V_{OP} = 5.4V, I_{OP} = 100mA$			150	mV
Line Regulation		ΔV_{LINE_OP}	V _{IN} = 2.5 to 5.5V, I _{OP} = 40mA		2		mV
Load Regulation		ΔV_{LOAD} OP	$\Delta IOP = 80mA$		3		%/A
Fast Discharge Re	esistance	RDISP			70		Ω
Negative Charge	Pump						
Negative Output V Range	oltage	Von		-4		-6	V
Negative Output V Setting Range	oltage	VON_SET	per step		100		mV
Negative Output V Accuracy	oltage	V _{ON_ACC}		-1		1	%
Negative Output C Capability	urrent	I _{ON_MAX}				80	mA
Negative Charge F Switching Frequer		f _{OSC_N}		0.8	1	1.2	MHz
Line Regulation		ΔVLINE_ON	$V_{IN} = 2.5 \text{ to } 5.5 \text{V}, I_{ON} = 40 \text{mA}$		10		mV
Load Regulation		ΔV_{LOAD} ON	$\Delta I_{ON} = 80 \text{mA}$		6		%/A
Fast Discharge Re	esistance	RDISN			20		Ω
Logic Input (ENP	ENN, SCL, S	SDA)					
Input Threshold	Logic-High	V _{IH}	V _{IN} =2.5V to 5.5V	1.2			V
Voltage	Logic-Low	V _{IL}	V _{IN} =2.5V to 5.5V			0.4	V
ENP, ENN Pull-do	wn	R _{EN}			200		kΩ
SDA, SCL Sink Cu	ırrent	I _{IH}	V _{SDA} , V _{SCL} = 3V		0.5		μΑ
SDA, SCL Logic Low-Level		V _{SCL_L}				0.4	V
Input Voltage	High-Level	V _{SCL_H}		1.2			v
SCL Clock Freque	ncy	fclk				400	kHz
Output Fall Time		tFL2COUT				250	ns
Bus Free Time Be Stop/Start	tween	tBUF		1.3			μS

RT4801H



Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Hold Time Start Condition	thd,sta		0.6			μS
Setup Time for Start Condition	tsu,sta		0.6			μS
SCL Low Time	tLOW		1.3			μS
SCL High Time	thigh		0.6			μS
Data Setup Time	tsu,dat		100			ns
Data Hold Time	thd,dat		0		900	ns
Setup Time for Stop Condition	tsu,sto		0.6			μS

- Note 1. Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at $T_A = 25$ °C on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. Totp, Totp Hyst are guaranteed by design.



Typical Application Circuit

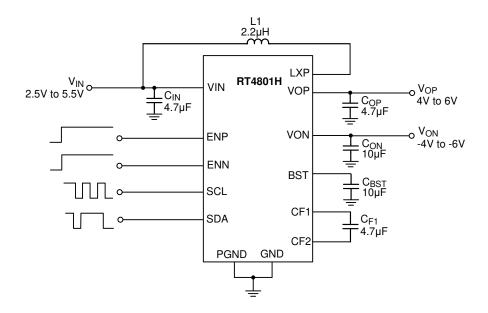
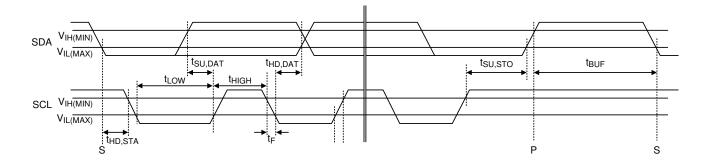


Table 1. Component List of Evaluation Board

Reference	Qty.	Part Number	Description	Package	Supplier
CIN, COP, CF1	1	GRM188R61C475KAAJ	4.7μF/16V/X5R	0603	Murata
C _{BST} , C _{ON}	1	GRM188R61C106KAAL	10μF/16V/X5R	0603	Murata
L1	1	1269AS-H-4R7N = P2	$2.2 \mu H/130 m \Omega$	2.5mm x 2.0mm x 1.0mm	Toko



I²C Interface





I²C Command

Slave Address

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 = LSB
1	1	1	0	0	1	1	R/W

Write Command

(a) Write single byte of data to Register

Slave Addres	S	Register Address	SS Data From Master
Start 1 1 1 0 0	1 1 0 Slave ACK R	7 R6 R5 R4 R3 R2	R2 R1 R0 Slave D7 D6 D5 D4 D3 D2 D1 D0 Slave ACK Stop

(b) Write multiple bytes of data to Registers



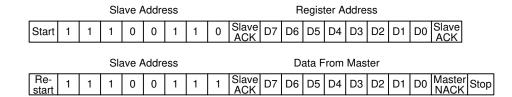
(n + 1)_{th} Data From Master

Last Data From Master

D7 D6 D5 D4 D3 D2 D1 D0 Slave ACK Stop

Read Command

(a) Read single byte of data from Register



(b) Read multiple bytes of data from Registers



	Slave Address						n _{th} Data From Master				Last Data From Master															
Re- start	1	1	1	0	0	1	1	1	Slave ACK D7	D6	D5	D4	D3	D2	D1	D0	Master ACK	 D7	D6	D5	D4	D3	D2	D1	D0	Master NACK Stop

Start : Start command ACK : Acknowledge = L active

R7 to R0 : Register Address. D7 to D0 : Write data when WRITE command or read

VOP : Register address = 0X00h data when READ command

VON : Register address = 0X01h Stop : Stop command

DISP: Register address = 0x03h DISN: Register address = 0x03h APPS: Register address = 0x03h

R/W: Read active (R/W = H) or Write active (R/W = L)

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Registers Map

Table 2. VOP Voltage Selection

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VOP(V)
VOP	00h	00h	Reserved	Reserved	Reserved	0	0	0	0	0	4
VOP	00h	01h	Reserved	Reserved	Reserved	0	0	0	0	1	4.1
VOP	00h	02h	Reserved	Reserved	Reserved	0	0	0	1	0	4.2
VOP	00h	03h	Reserved	Reserved	Reserved	0	0	0	1	1	4.3
VOP	00h	04h	Reserved	Reserved	Reserved	0	0	1	0	0	4.4
VOP	00h	05h	Reserved	Reserved	Reserved	0	0	1	0	1	4.5
VOP	00h	06h	Reserved	Reserved	Reserved	0	0	1	1	0	4.6
VOP	00h	07h	Reserved	Reserved	Reserved	0	0	1	1	1	4.7
VOP	00h	08h	Reserved	Reserved	Reserved	0	1	0	0	0	4.8
VOP	00h	09h	Reserved	Reserved	Reserved	0	1	0	0	1	4.9
VOP	00h	0Ah	Reserved	Reserved	Reserved	0	1	0	1	0	5
VOP	00h	0Bh	Reserved	Reserved	Reserved	0	1	0	1	1	5.1
VOP	00h	0Ch	Reserved	Reserved	Reserved	0	1	1	0	0	5.2
VOP	00h	0Dh	Reserved	Reserved	Reserved	0	1	1	0	1	5.3
VOP	00h	0Eh	Reserved	Reserved	Reserved	0	1	1	1	0	5.4
VOP	00h	0Fh	Reserved	Reserved	Reserved	0	1	1	1	1	5.5
VOP	00h	10h	Reserved	Reserved	Reserved	1	0	0	0	0	5.6
VOP	00h	11h	Reserved	Reserved	Reserved	1	0	0	0	1	5.7
VOP	00h	12h	Reserved	Reserved	Reserved	1	0	0	1	0	5.8
VOP	00h	13h	Reserved	Reserved	Reserved	1	0	0	1	1	5.9
VOP	00h	14h	Reserved	Reserved	Reserved	1	0	1	0	0	6

Table 3. VON Voltage Selection

					_						
Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VON(V)
VON	01h	00h	Reserved	Reserved	Reserved	0	0	0	0	0	-4
VON	01h	01h	Reserved	Reserved	Reserved	0	0	0	0	1	-4.1
VON	01h	02h	Reserved	Reserved	Reserved	0	0	0	1	0	-4.2
VON	01h	03h	Reserved	Reserved	Reserved	0	0	0	1	1	-4.3
VON	01h	04h	Reserved	Reserved	Reserved	0	0	1	0	0	-4.4
VON	01h	05h	Reserved	Reserved	Reserved	0	0	1	0	1	-4.5
VON	01h	06h	Reserved	Reserved	Reserved	0	0	1	1	0	-4.6
VON	01h	07h	Reserved	Reserved	Reserved	0	0	1	1	1	-4.7
VON	01h	08h	Reserved	Reserved	Reserved	0	1	0	0	0	-4.8
VON	01h	09h	Reserved	Reserved	Reserved	0	1	0	0	1	-4.9
VON	01h	0Ah	Reserved	Reserved	Reserved	0	1	0	1	0	-5
VON	01h	0Bh	Reserved	Reserved	Reserved	0	1	0	1	1	-5.1
VON	01h	0Ch	Reserved	Reserved	Reserved	0	1	1	0	0	-5.2



Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VON(V)
VON	01h	0Dh	Reserved	Reserved	Reserved	0	1	1	0	1	-5.3
VON	01h	0Eh	Reserved	Reserved	Reserved	0	1	1	1	0	-5.4
VON	01h	0Fh	Reserved	Reserved	Reserved	0	1	1	1	1	-5.5
VON	01h	10h	Reserved	Reserved	Reserved	1	0	0	0	0	-5.6
VON	01h	11h	Reserved	Reserved	Reserved	1	0	0	0	1	-5.7
VON	01h	12h	Reserved	Reserved	Reserved	1	0	0	1	0	-5.8
VON	01h	13h	Reserved	Reserved	Reserved	1	0	0	1	1	-5.9
VON	01h	14h	Reserved	Reserved	Reserved	1	0	1	0	0	-6

Table 4. VOP Active Discharge

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VOP Discharge
DISP	03h	00h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	0	DISN	W/O
DISP	03h	02h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	1	DISN	W

Table 5. VON Active Discharge

Na	me	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VON Discharge
DI	SN	03h	00h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	DISP	0	W/O
DI	SN	03h	01h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	DISP	1	W

Table 6. Application

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Application
APPS	03h	00h	Reserved	0	Reserved	Reserved	Reserved	Reserved	DISP	DISN	Tablet
APPS	03h	40h	Reserved	1	Reserved	Reserved	Reserved	Reserved	DISP	DISN	Smartphone

The Reserved bits are ignored when written and return either 0 or 1 when read.

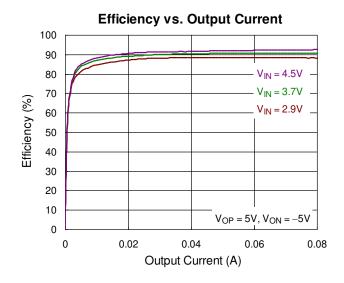
Factory Default Register Value

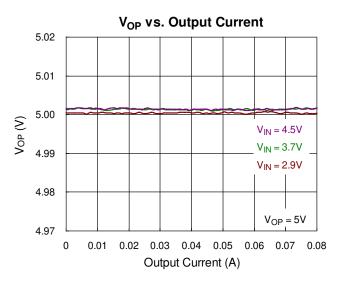
Name	Register Address	DATA
VOP	00h	0Ah
VON	01h	0Ah
DISP	03h	43h
DISN	03h	43h
APPS	03h	43h

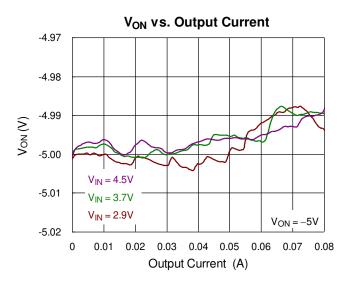
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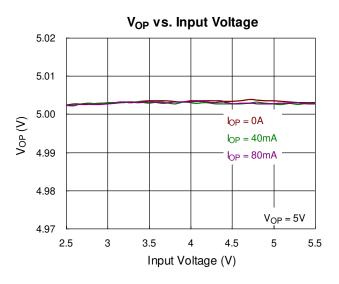


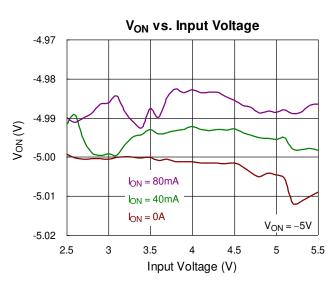
Typical Operating Characteristics

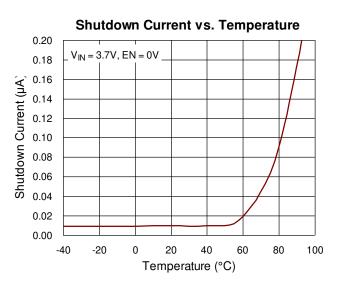




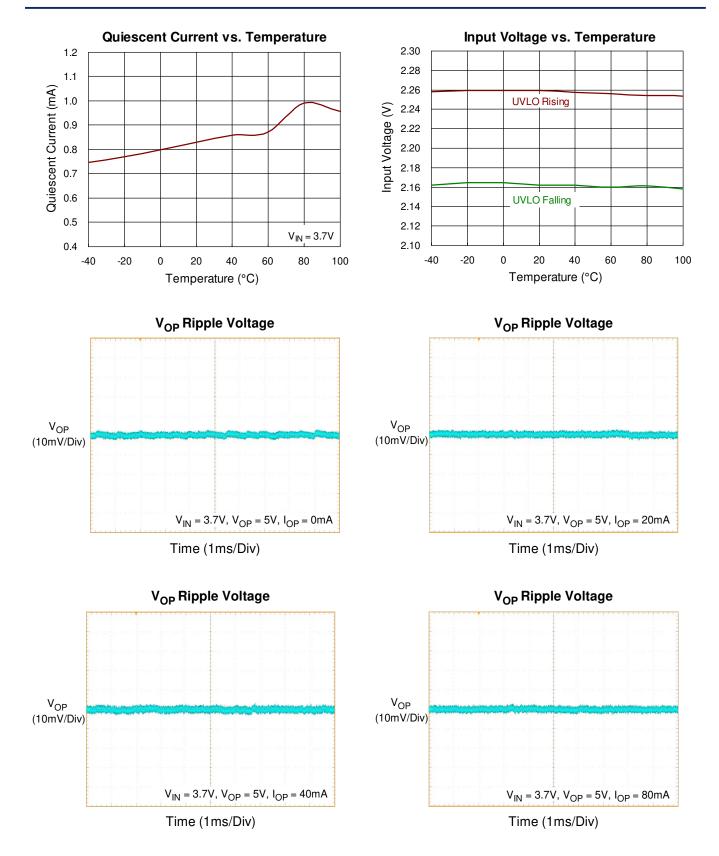




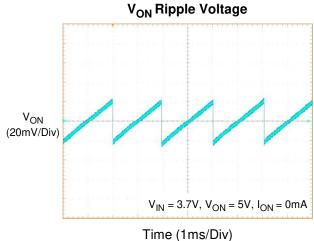


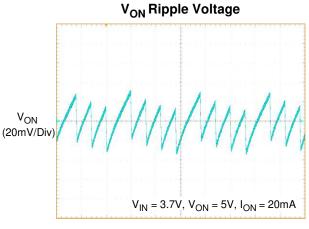




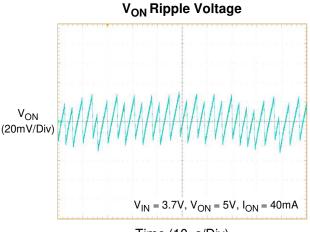


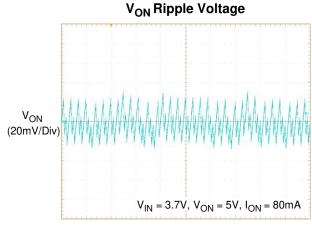


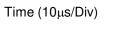


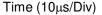


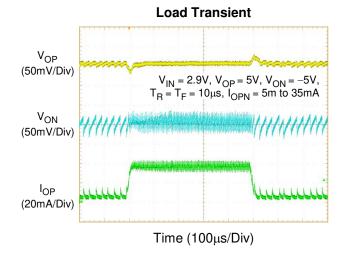


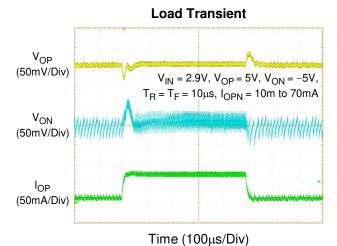




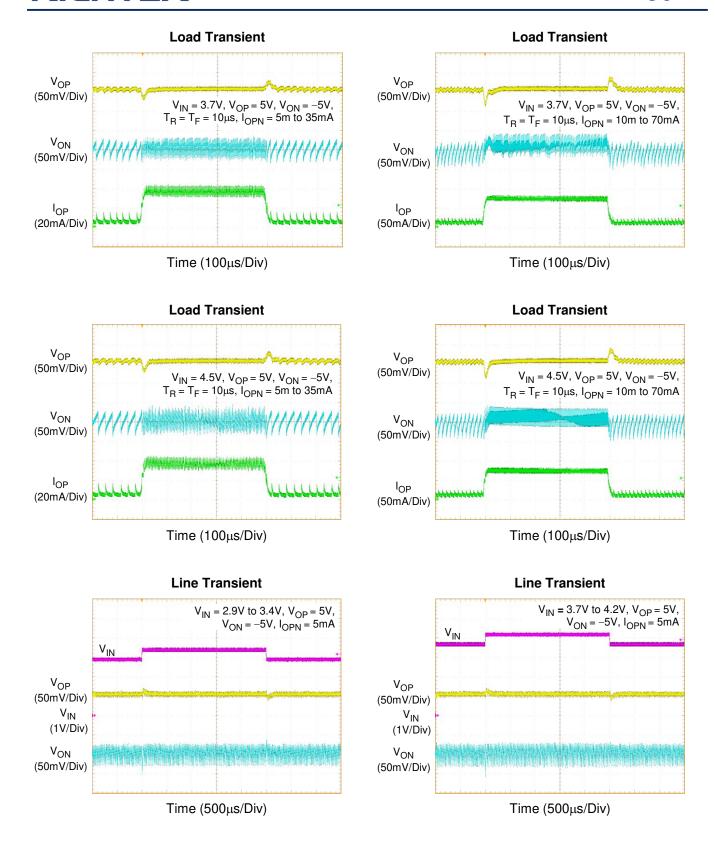




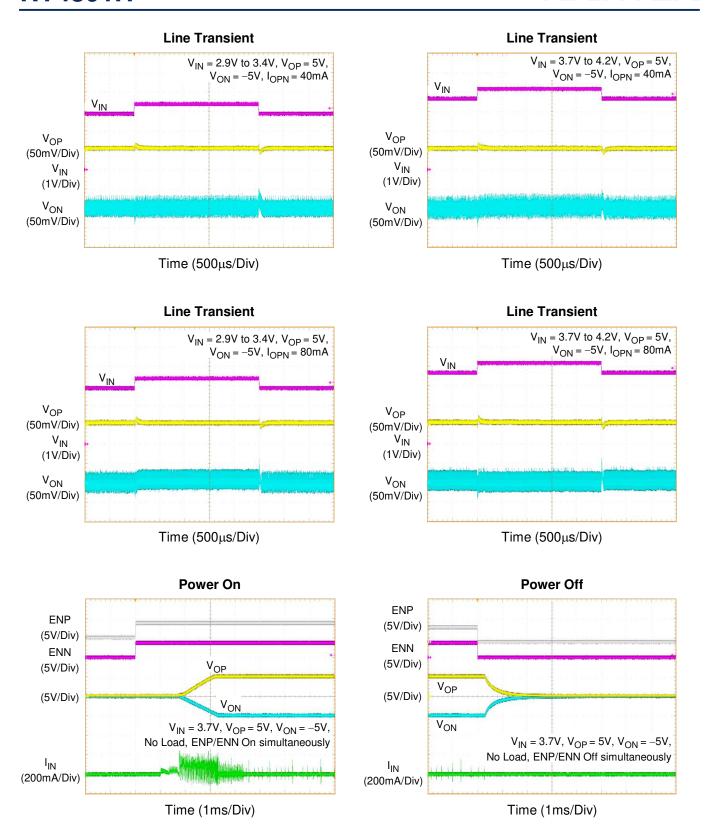




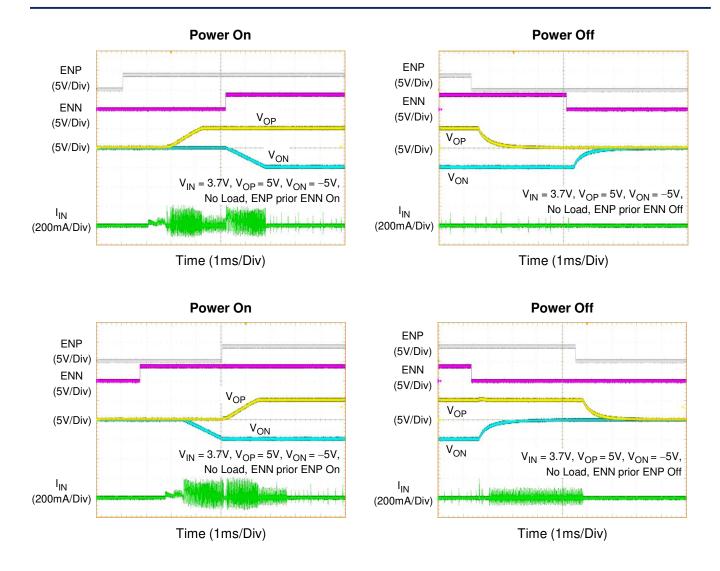














Application Information

The RT4801H is a highly integrated Boost, LDO and inverting charge pump to generate positive and negative output voltages for LCD panel bias or consumer products. It can support input voltage range from 2.5V to 5.5V and the output current up to 80mA. The VoP positive output voltage is generated from the LDO supplied from a synchronous Boost converter, and VOP is set at a typical value of 5V. The Boost converter output also drives an inverting charge pump controller to generate Von negative output voltage which is set at a typical value of -5V. Both positive and negative voltages can be programmed by a MCU through the dedicated I²C interface and the available voltage range is from $\pm 4V$ to $\pm 6V$ with 100mV per step.

Input Capacitor Selection

Input ceramic capacitor with 4.7µF capacitance is suggested for applications. For better voltage filtering, select ceramic capacitors with low ESR, X5R and X7R types are suitable because of their wider voltage and temperature ranges.

Boost Inductor Selection

The inductance depends on the maximum input current. As a general rule, the inductor ripple current range is 20% to 40% of the maximum input current. If 40% is selected as an example, the inductor ripple current can be calculated according to the following equations:

$$I_{IN(MAX)} = \frac{V_{OUT} \times I_{OUT(MAX)}}{\eta \times V_{IN}}$$

$$I_{RIPPLE} = 0.4 \times I_{IN(MAX)}$$

where η is the efficiency of the VOP Boost converter, $I_{IN(MAX)}$ is the maximum input current, and ΔI_L is the inductor ripple current. The input peak current can then be obtained by adding the maximum input current with half of the inductor ripple current as shown in the following equation:

$$I_{PEAK} = 1.2 \times I_{IN(MAX)}$$

Note that the saturated current of the inductor must be greater than IPEAK.

The inductance can eventually be determined according to the following equation:

$$L = \frac{\eta \times \left(V_{IN}\right)^2 \times \left(V_{OUT} - V_{IN}\right)}{0.4 \times \left(V_{OUT}\right)^2 \times I_{OUT(MAX)} \times f_{OSC}}$$

where fosc is the switching frequency. For better system performance, a shielded inductor is preferred to avoid EMI problems.

Boost Output Capacitor Selection

The output ripple voltage is an important index for estimating IC performance. This portion consists of two parts. One is the product of ripple current with the ESR of the output capacitor, while the other part is formed by the charging and discharging process of the output capacitor. As shown in Figure 1, ΔV_{OUT1} can be evaluated based on the ideal energy equalization. According to the definition of Q, the ΔV_{OUT1} value can be calculated as the following equation:

$$Q = I_{OUT} \times D \times \frac{1}{f_{SOC}} = C_{OUT} \times \Delta V_{OUT1}$$
$$\Delta V_{OUT1} = \frac{I_{OUT} \times D}{f_{SOC} \times C_{OUT}}$$

where fosc is the switching frequency and D is the duty cycle.

Finally, taking ESR into consideration, the overall output ripple voltage can be determined by the following equation:

$$\Delta V_{OUT} = \Delta V_{ESR} + \Delta V_{OUT1} = \Delta V_{SER} + \frac{I_{OUT} \times D}{f_{OSC} \times C_{OUT}}$$

where $\Delta V_{ESR} = I_{Crms} \times R_{CESR}$

The output capacitor, Cout, should be selected accordingly.



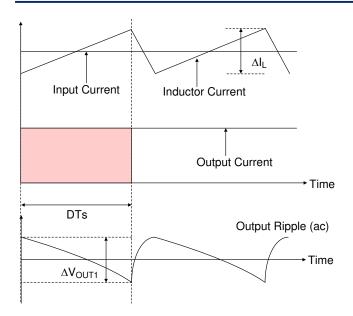


Figure 1. The Output Ripple Voltage without the Contribution of ESR

Under Voltage Lockout

To prevent abnormal operation of the IC in low voltage condition, an under voltage lockout is included which shuts down IC operation when input voltage is lower than the specified threshold voltage.

Soft-Start

The RT4801H employs an internal soft-start feature to avoid high inrush current during start-up. The soft-start function is achieved by clamping the output voltage of the internal error amplifier with another voltage source that is increased slowly from zero to near VIN during the soft-start period.

Output Voltage Setting

The output voltage of WL-CSP package can be programmed by a MCU through the dedicated I^2C interface according to the Vop/Von Voltage Selection Table.

Shutdown Delay and Discharge

When the EN signal is logic low for more than $375\mu s$, the IC function will be shut down. The output V_{OP}/V_{ON} can be actively discharged to GND via discharge selection bit enabled. In shutdown mode, the input supply current for the IC is less than $1\mu A$.

Over Current Protection

The RT4801H includes a cycle-by-cycle current limit function which monitors the inductor current during each ON period. The power switch will be forced off to avoid large current damage once the current is over the limit level.

Short Circuit Protection

The RT4801H has an advanced output short-circuit protection mechanism which prevents the IC from damage by unexpected applications.

VOP short to ground

When the output voltage is under the limit level with 1ms (typ.) duration, the LCD bias function enters shutdown mode and can only re-start to normal operation after triggering the ENP/ENN pin.

VON short to ground

The output will keep current limit status without shutdown and re-start to normal operation once short condition removed.

Over Temperature Protection

The RT4801H equips an over temperature protection circuitry to prevent overheating due to excessive power dissipation. The OTP will shut down LCD bias operation when ambient temperature exceeds 140°C. Once the ambient temperature cools down by approximately 15°C, IC will automatically resume normal operation. To maintain continuous operation, the maximum junction temperature should be prevented from rising above 125°C.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications,

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the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For WL-CSP-15B 1.31x2.07 package, the thermal resistance, θ_{JA} , is 49.8°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at $T_A = 25^{\circ}C$ can be calculated by the following formula:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (49.8^{\circ}C/W) = 2W \text{ for}$ WL-CSP-15B 1.31x2.07 (BSC) package

The maximum power dissipation depends on the operating ambient temperature for fixed T_{J(MAX)} and thermal resistance, θ_{JA} . The derating curve in Figure 2 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

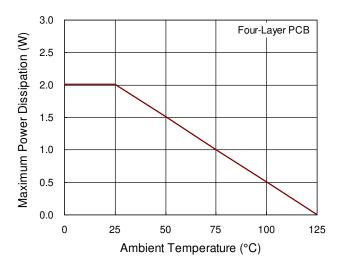


Figure 2. Derating Curve of Maximum Power Dissipation

Layout Considerations

For the best performance of RT4801H, the following PCB layout guidelines should be strictly followed.

- ▶ For good regulation, place the power components as close to the IC as possible. The traces should be wide and short especially for the high current output loop.
- ▶ The input and output bypass capacitor should be placed as close to the IC as possible and connected to the ground plane of the PCB.
- ▶ The flying capacitor should be placed as close to the CF1/CF2 pin as possible to avoid noise injection.
- ▶ Minimize the size of the LXP node and keep the traces wide and short. Care should be taken to avoid running traces that carry any noise-sensitive signals near LXP or high-current traces.
- ▶ Separate power ground (PGND) and analog ground (GND). Connect the GND and the PGND islands at a single end. Make sure that there are no other connections between these separate ground planes.

DS4801H-00

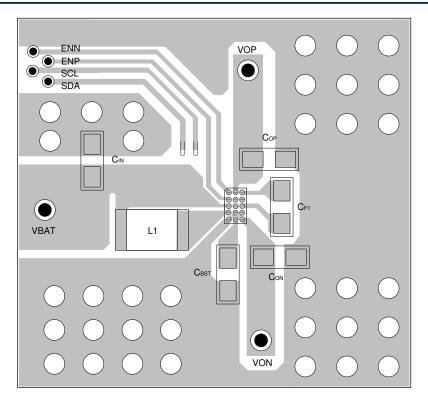
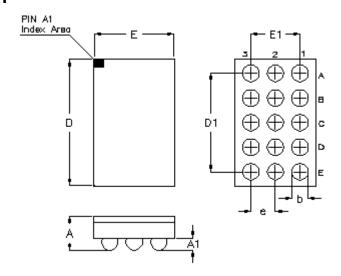


Figure 3. PCB Layout Guide



Outline Dimension



Cymhol	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
Α	0.500	0.600	0.020	0.024		
A1	0.170	0.230	0.007	0.009		
b	0.240	0.300	0.009	0.012		
D	2.020	2.120	0.080	0.083		
D1	1.6	600	0.063			
E	1.260	1.360	0.050	0.054		
E1	0.8	300	0.031			
е	0.4	100	0.016			

WL-CSP-15B 1.31x2.07 (BSC)

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